# SMD thermal fuse for high currents





RTS-AS500

# 60 VDC · up to 130 A · >210 °C · PCB, SMT

### Description

- Patented surface mount thermal fuse to protect against thermal runaway of power semiconductors such as: MOSFET's, IC's, IGBT's, Triac's, SCR's, etc.
- Highest reliability thanks to complete galvanic Separation.

## **Unique Selling Proposition**

- Separates rated voltages up to 60 VDC
- Reflow compatible through mechanical activation procedure
- Galvanic separation happens inside the RTS housing
- Space-saving thanks to integrated shunt

#### See below: Approvals and Compliances

### Applications

- Wherever power transistors are used
- Automotive: Cooling fan applications, ABS power steering, PTC heaters, HVAC, Glow plugs, Diesel fuel heaters
- Industrial: Battery Protection, Power supplies, Lighting ballasts, H-Bridge circuits, Motor drivers

# Other versions on request

- Thermal protection with integrated fuse
- Thermal protection with customer specific resistance
- Thermal protection with customer specific tripping temperature

### Weblinks

pdf data sheet, html datasheet, General Product Information, Packaging details, Distributor-Stock-Check, Detailed request for product, Landing Page, Video

Technical Data	
Rated Voltage	60VDC
Breaking Capacity	400 A
Operating current	up to 130A
Mounting	PCB,SMT
Allowable Operation Tempe-	-40 °C to +150 °C
rature	
Tripping temperature	>210°C
Material: Housing	Plastics
Material: Terminals	Tin-Plated Copper Alloy
Unit Weight	0.75 g
Storage Conditions	0°C to 40°C, max. 70% r.h.
Product Marking	Variant Code, Lot no.
Activation force	Fa = max. 50 N
Activation distance	Sa = 1.1 +0.3/-0.1 mm
Maximum reflow temperature	260 °C (peak)

Soldering Methods	Reflow
	Soldering Profile
Solderability	JESD22-B102E, Method 1
Resistance to Soldering Heat	JEDEC J-STD-020
Moisture Sensitivity Level	MSL 1, J-STD-020
Damp heat, steady state	MIL-STD-202, Method 103
Thermal Shock	MIL-STD-202, Method 107
Operational Life	MIL-STD-202, Method 108 Condition D
Vibration, High Frequency	MIL-STD-202, Method 204 Condition D
Mechanical Shock	MIL-STD-202, Method 213 Condition B
Resistance to Solvents	MIL-STD-202, Method 215
Temperature Cycling	JESD22 Method JA-104 Test Condi-
	tions G
Flame Retardance	AEC-Q200-001 + SAG Specification
Board Flex	AEC-Q200-005
Terminal Strength	AEC-Q200-006

## **Approvals and Compliances**

Detailed information on product approvals, code requirements, usage instructions and detailed test conditions can be looked up in Details about Approvals

SCHURTER products are designed for use in industrial environments. They have approvals from independent testing bodies according to national and international standards. Products with specific characteristics and requirements such as required in the automotive sector according to IATF 16949, medical technology according to ISO 13485 or in the aerospace industry can be offered exclusively with customer-specific, individual agreements by SCHURTER.

### **Application standards**

Application standards where the product can be used

Organization	Design	Standard	Description
IEC	Designed for applications acc.	IEC/UL 60950	IEC 60950-1 includes the basic requirements for the safety of information technology equipment.

# RTS

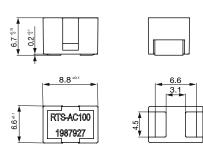
# Compliances

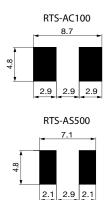
The product complies with following Guide Lines

Identification	Details	Initiator	Description
RoHS	RoHS	SCHURTER AG	Directive RoHS 2011/65/EU, Amendment (EU) 2015/863
REACH	REACH	SCHURTER AG	On 1 June 2007, Regulation (EC) No 1907/2006 on the Registration, Evaluation, Authorization and Restriction of Chemicals 1 (abbreviated as "REACH") entered into force.
AEC Q200	Automotive	SCHURTER AG	AEC-Q200 is a test standard for passive components used in automotive applications. SCHURTER tests components according to the customer's agreement and is certified according to IATF 16949.

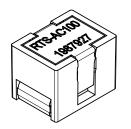
# Dimension [mm]

Reflow soldering pads





Activation status



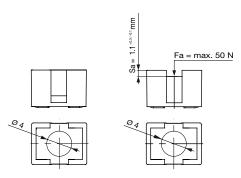
Deactivated: Before reflow the activation button should not be manipulated with a force greater 5 newton.

# Pro-Across and rest

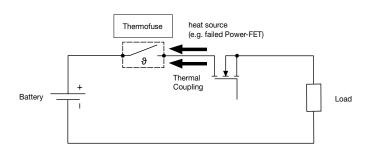
### Activated:

Activation after reflow is necessary for the tripping funcionality of the RTS. This activation is done by mechanically pressing the activation button with max 50 newton.

# Activation specification



# Diagrams



# **Derating Curves**

70

50

30

10

-10

-30 --40

-10

Ambient Temperature [°C]

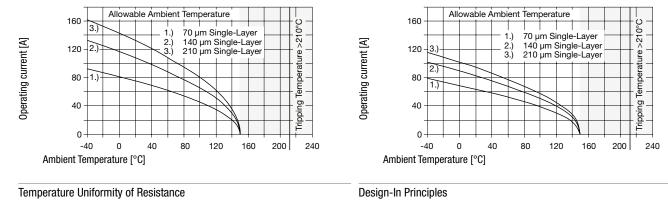
20

50

80

# Derating Curve without Shunt

Derating Curve with Shunt



- > The RTS should be placed as close as possible to the heat source (power semiconductor).
- > Max. nominal current depends on ambient temperature and on the PCB track implementation (see Derating Curves).
- > The derating curves were generated using a PCB acc. to IEC 60127-4 with a layer width of 20 mm.
- If operating current is higher than allowed, consider using two RTS in parallel. This doubles the max. current value in the derating curve.

### **All Variants**

Deviation of resistance [%]

Variant Code	Shunt	Cold Resistance [ $\mu\Omega$ ]	Packaging unit [PCS]	Order Number
RTS-AC100		90 - 110	100	3-104-513
RTS-AC100		90 - 110	750	3-104-514
RTS-AS500	•	500 - 580	100	3-119-589
RTS-AS500	•	500 - 580	750	3-119-590

Availability for all products can be searched real-time:https://www.schurter.com/en/Stock-Check/Stock-Check-SCHURTER

Without Sh

110

Shunt

150

Breaking Capacity: 400 A @ 24 VDC (> 18 µH) / 200 A @ 50 VDC (> 27 µH) / 170 A @ 60 VDC (> 32 µH)

Packaging Unit Blister Tape 33 cm Reel in ESD Plastic Bag